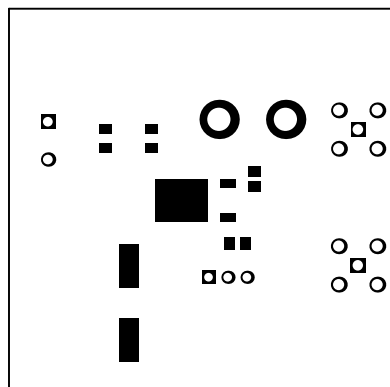
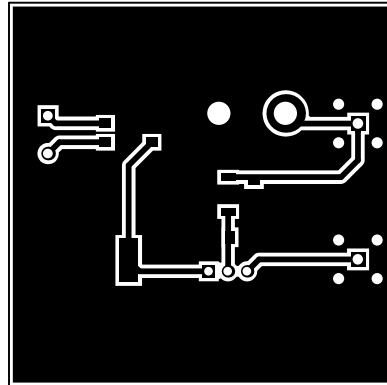


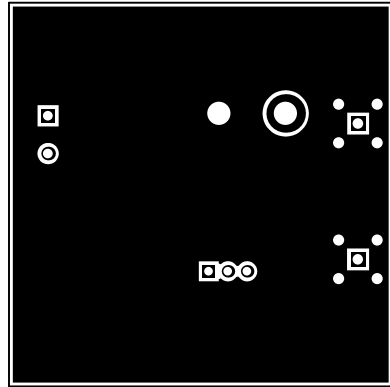
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 12/21/2015 11:26:13 AM	TEXAS INSTRUMENTS	



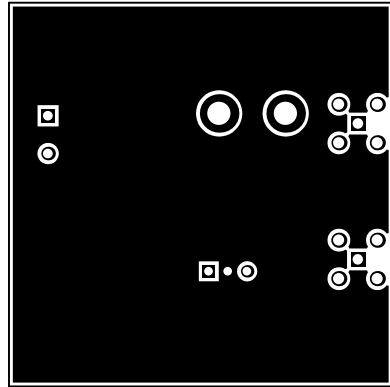
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 12/21/2015 11:26:14 AM	TEXAS INSTRUMENTS	



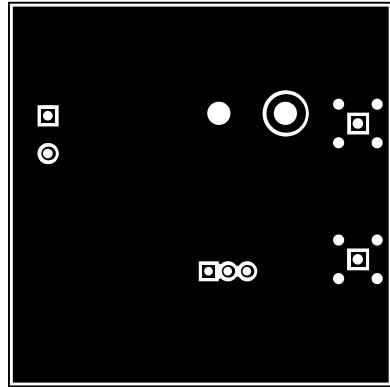
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L1<TOP>			
PLOT NAME = Top Layer	GENERATED : 12/21/2015 11:26:15 AM	TEXAS INSTRUMENTS	



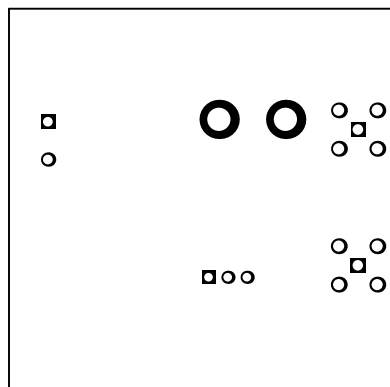
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 1	GENERATED : 12/21/2015 11:26:16 AM	TEXAS INSTRUMENTS	



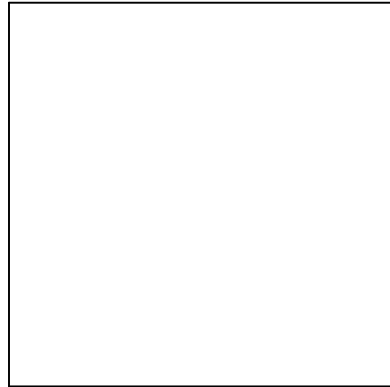
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 2	GENERATED : 12/21/2015 11:26:17 AM	TEXAS INSTRUMENTS	



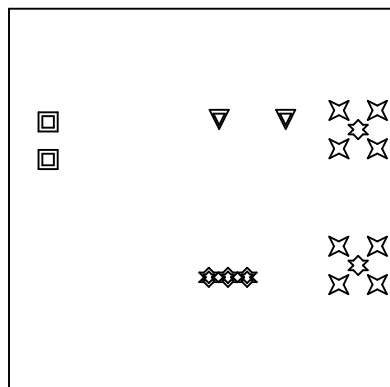
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L4(BOT)			
PLOT NAME = Bottom Layer	GENERATED : 12/21/2015 11:26:18 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 12/21/2015 11:26:19 AM	TEXAS INSTRUMENTS	

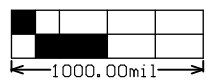
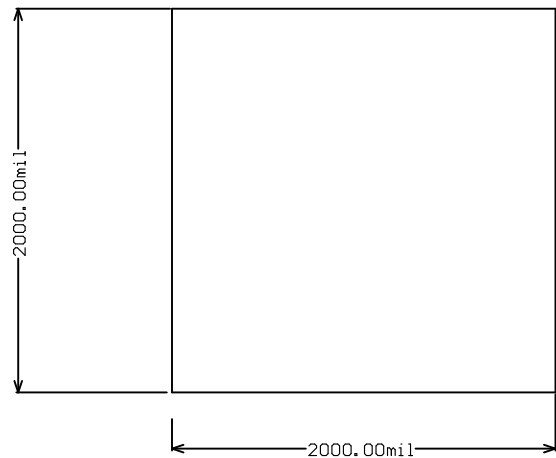


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 12/21/2015 11:26:20 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
★	3	45.28mil (1.150mm)	PTH	Round
■	2	51.18mil (1.300mm)	PTH	Round
⚙	2	55.12mil (1.400mm)	PTH	Round
✳	8	59.06mil (1.500mm)	PTH	Round
▼	2	122.65mil (3.100mm)	PTH	Round
	17 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 12/21/2015 11:26:21 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00896	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 12/21/2015 11:26:22 AM	TEXAS INSTRUMENTS	

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